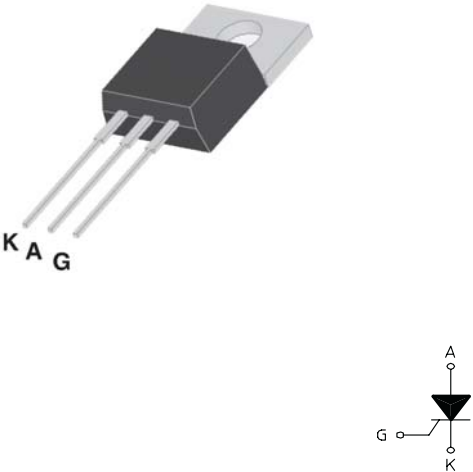


STANDARD SCR

TO220-AB 	On-State Current 25 Amp Gate Trigger Current 2 mA to 40 mA Off-State Voltage 200 V to 800 V These series of Silicon Controlled Rectifier use a high performance PNP technology. These parts are intended for general purpose applications where high gate sensitivity is required.
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Absolute Maximum Ratings, according to IEC publication No. 134

SYMBOL	PARAMETER	CONDITIONS	Value	Unit
$I_{T(RMS)}$	On-state Current	180° Conduction Angle, $T_c = 110\text{ °C}$	25	A
$I_{T(AV)}$	Average On-state Current	Half Cycle, $\Theta = 180\text{ °}$, $T_c = 110\text{ °C}$	16	A
I_{TSM}	Non-repetitive On-State Current	Half Cycle, 60 Hz	270	A
I_{TSM}	Non-repetitive On-State Current	Half Cycle, 50 Hz	250	A
I^2t	Fusing Current	$t_p = 10\text{ms}$, Half Cycle	313	A ² s
I_{GM}	Peak Gate Current	20 μs max.	4	A
P_{GM}	Peak Gate Dissipation	20 μs max.	10	W
$P_{G(AV)}$	Gate Dissipation	20ms max.	1	W
T_j	Operating Temperature		(-40 to +125)	°C
T_{stg}	Storage Temperature		(-40 to +150)	°C
T_{sld}	Soldering Temperature	10s max.	260	°C
V_{RGM}	Reverse Gate Voltage		5	V

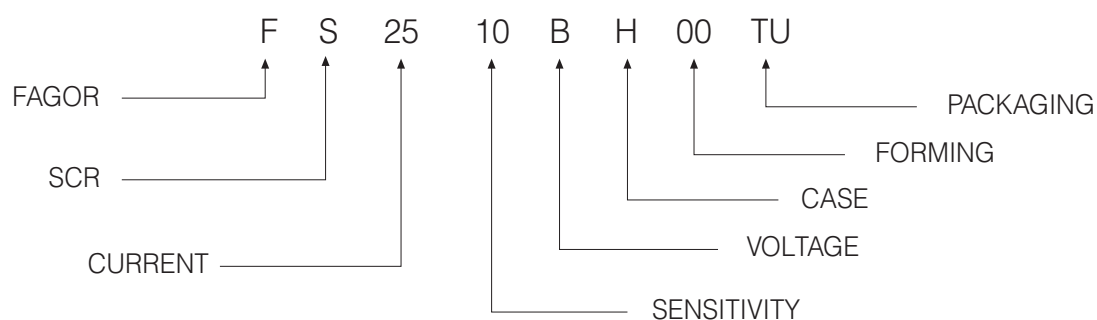
SYMBOL	PARAMETER	CONDITIONS	VOLTAGE					Unit
			B	D	M	S	N	
V_{DRM} V_{RRM}	Repetitive Peak Off State Voltage	$R_{GK} = 1\text{ k}\Omega$	200	400	600	700	800	V

STANDARD SCR

Electrical Characteristics

SYMBOL	PARAMETER	CONDITIONS		SENSITIVITY		Uni
				10	14	
I _{GT}	Gate Trigger Current	V _D = 12 V _{DC} , R _L = 33Ω. T _j = 25 °C	MIN MAX	2 25	4 40	m A
V _{GT}	Gate Trigger Voltage	V _D = 12 V _{DC} , R _L = 33Ω, T _j = 25 °C	MAX	1.3		V
V _{GD}	Gate Non Trigger Voltage	V _D = V _{DRM} , R _L = 3.3kΩ, R _{GK} = 220Ω T _j = 125 °C	MIN	0.2		V
I _H	Holding Current	I _T = 500 mA,	MAX	40	50	mA
I _L	Latching Current	I _G = 1.2 I _{GT}	MAX	60	90	mA
dV / dt	Critical Rate of Voltage Rise	V _D = 0.67 x V _{DRM} , Gate open T _j = 125 °C	MIN	500	1000	V/μs
dI / dt	Critical Rate of Current Rise	I _G = 2 x I _{GT} Tr ≤ 100 ns, f = 60 Hz, T _j = 125 °C	MIN	50	100	A/μs
V _{TM}	On-state Voltage	at I _T = 50 Amp, tp = 380 μs, T _j = 25 °C	MAX	1.6		V
V _{t0}	Threshold Voltage	T _j = 125 °C	MAX	0.75		V
r _d	Dynamic resistance	T _j = 125 °C	MAX	14		mΩ
I _{DRM} / I _{RRM}	Off-State Leakage Current	V _D = V _{DRM} , R _{GK} = 1kΩ T _j = 125 °C	MAX	2		mA
			V _R = V _{RRM} , T _j = 25 °C	MAX	5	
R _{th(j-c)}	Thermal Resistance Junction-Case for DC	for AC 360 ° conduction angle		1		°C/W
R _{th(j-a)}	Thermal Resistance Junction-Amb for DC	S = 1 cm ²		60		°C/W

PART NUMBER INFORMATION



STANDARD SCR

Fig. 1: Maximum average power dissipation versus average on-state current.

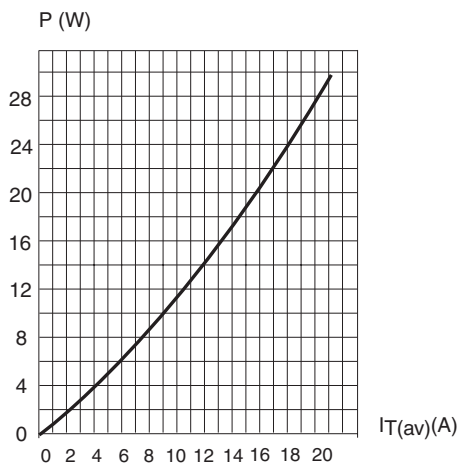


Fig. 2: Average and D.C. on-state current versus case temperature.

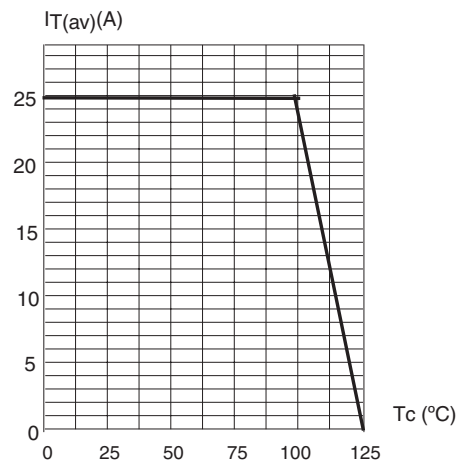


Fig. 3: Relative variation of thermal impedance junction to case versus pulse duration.

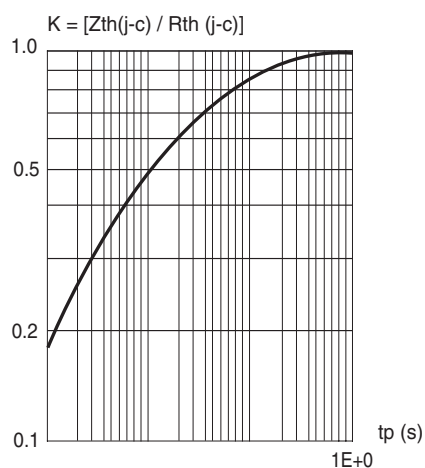


Fig. 4: Relative variation of gate trigger current, holding and latching current versus junction temperature.

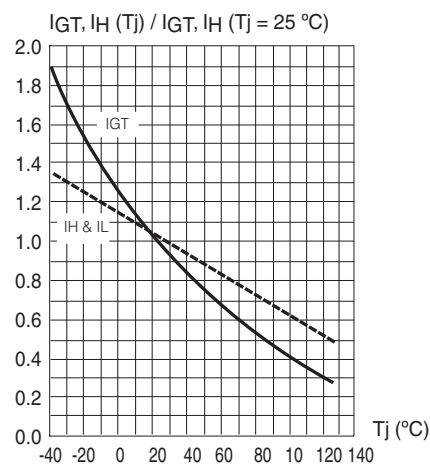


Fig. 5: Non repetitive surge peak on-state current versus number of cycles.

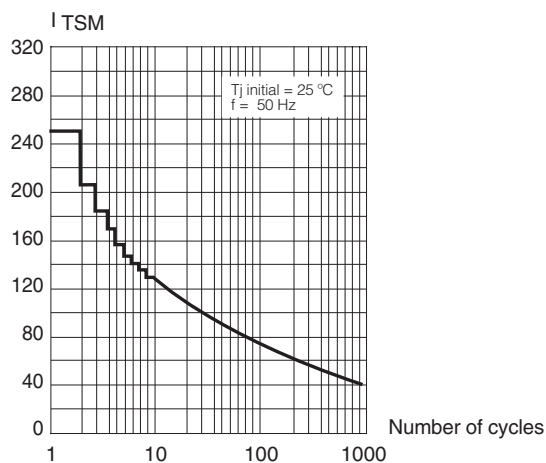
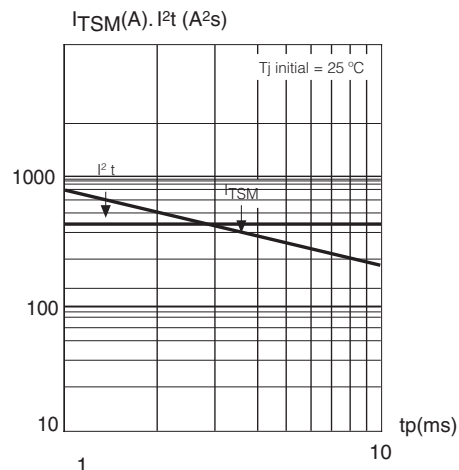
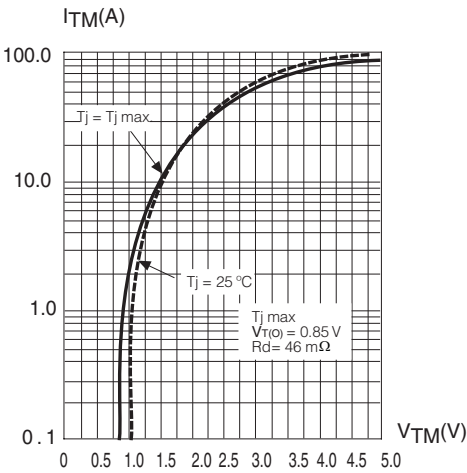


Fig. 6: Non repetitive surge peak on-state current for a sinusoidal pulse with width: $t_p < 10 \text{ ms}$, and corresponding value of I^2t .



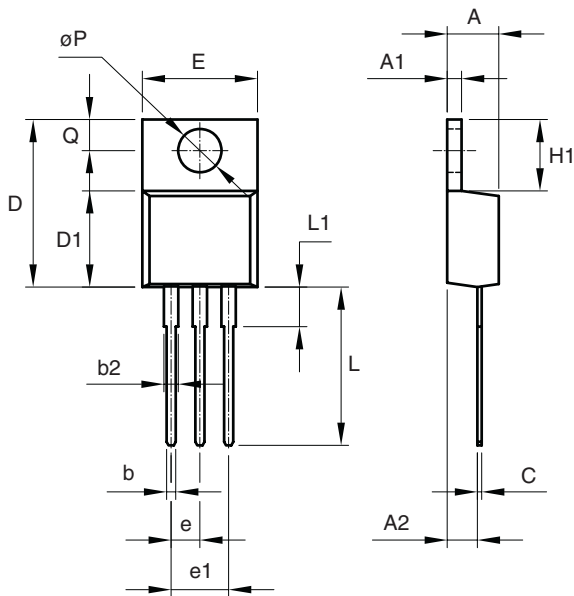
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Fig. 7: On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA

TO-220AB



REF.	DIMENSIONS	
	Milimeters	
	Min.	Max.
A	4.47	4.67
A1	1.17	1.37
A2	2.52	2.82
b	0.71	0.91
b2	1.17	1.37
c	0.31	0.53
D	14.65	15.35
D1	8.50	8.90
E	10.01	10.36
e	2.51	2.57
e1	4.98	5.18
H1	6.15	6.45
L	13.40	13.96
L1	3.56	3.96
P	3.735	3.935
Q	2.59	2.89

Mounting Torque

1 N.m

(*) Limiting values and life support applications, see Web page.